

Investigations of the Charge Limit Phenomenon in GaAs Photocathodes

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Outline:

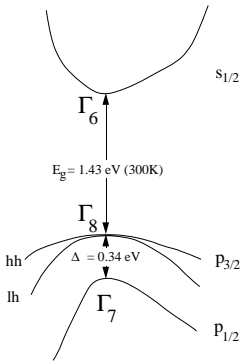
Introduction

- Charge limit vs. doping concentration
- Polarization with high surface doping
- Possible solutions

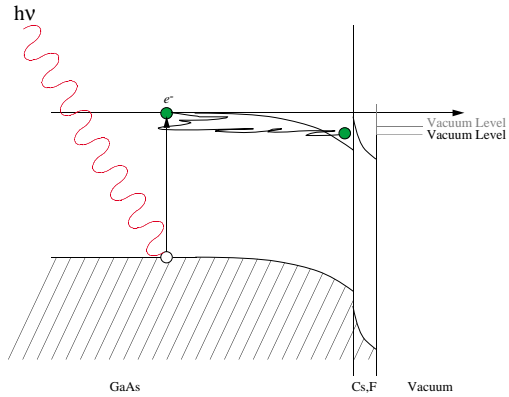
Summary

Surface Charge Limit

Charge output is not proportional to light intensity



GaAs band structure in vicinity of Γ point



NEA Surface

- Photon absorption excites electrons to conduction band
- Electrons can be trapped near the surface
- Electrostatic potential from trapped electrons raises affinity
- Increased affinity decreases emission probability
- Affinity recovers after electron recombination
- Increasing photon flux counterproductive at extremes

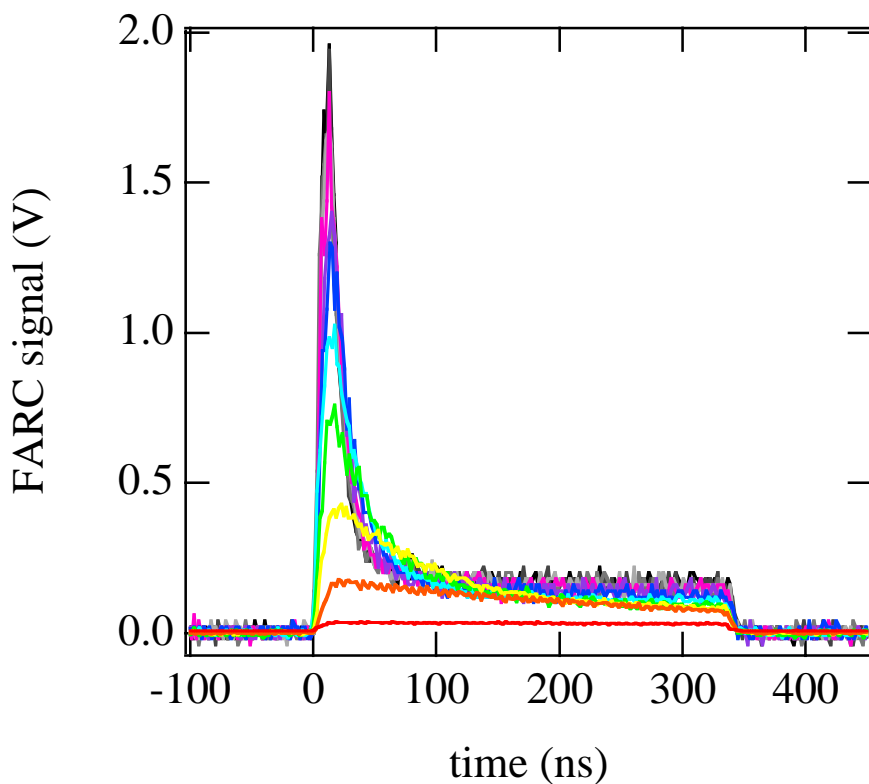
M. Woods, et al J. Appl. Phys. 9, 2295 (1994)

K. Togawa, et al Nucl. Instr. and Methods A365, 1 (1995)

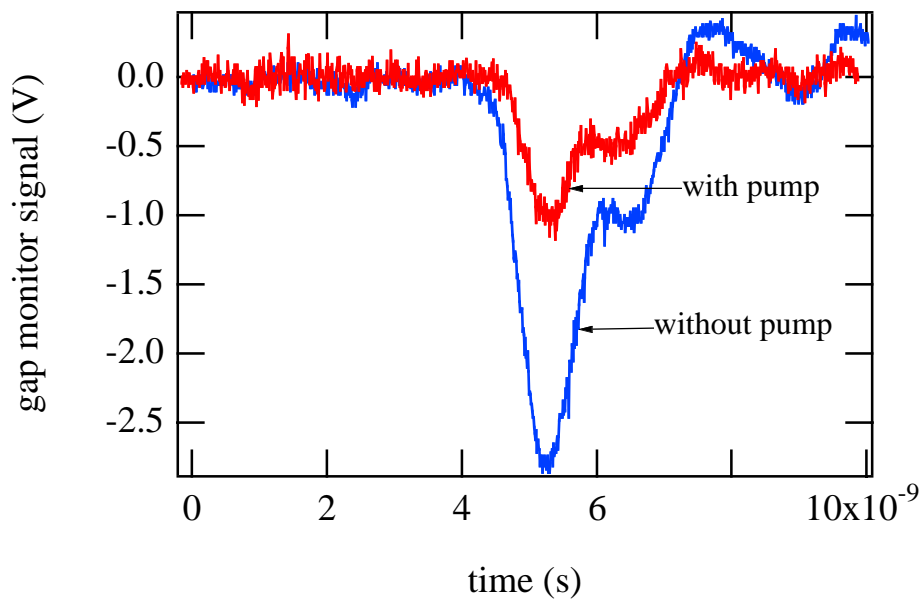
A.S. Jaroshevich, et al, 7th Int. Workshop on Polarized Gas Targets and Polarized Beams, Urbana, USA (1997)

A. Herrera-Gomez, et al J. Appl. Phys. 79, 7318 (1996)

ong Pulse Signal

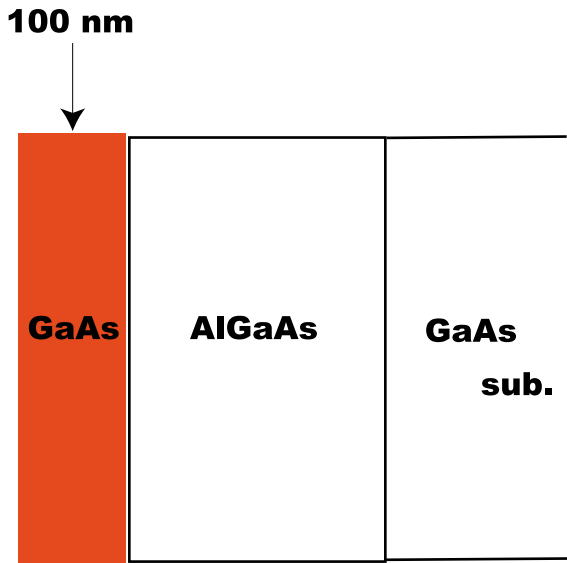


robe Signal with/without Pump Pulse



Charge Limit vs. Doping Concentration

Sample: thin unstrained GaAs



Doping concentration:

$$5 \cdot 10^{18}, \quad 1 \cdot 10^{19}, \quad 2 \cdot 10^{19}, \quad 5 \cdot 10^{19} \text{ cm}^{-3}$$

Laser:

Flash-lamp pumped Ti:sapphire

Pulse length: 100 ~ 350 nsec

YAG pumped Ti:sapphire

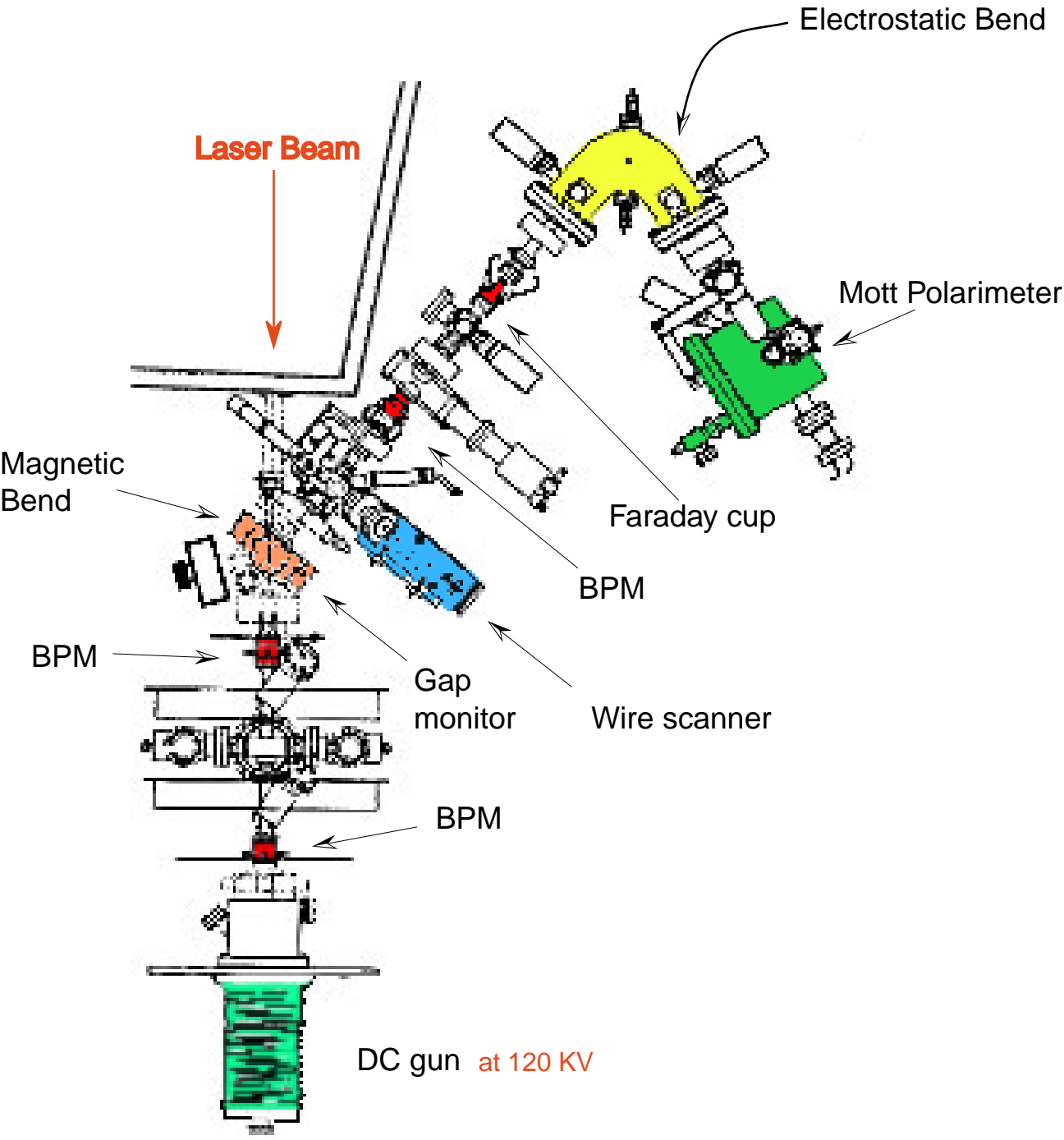
Pulse length: 2 nsec

Two pulses with variable time separation

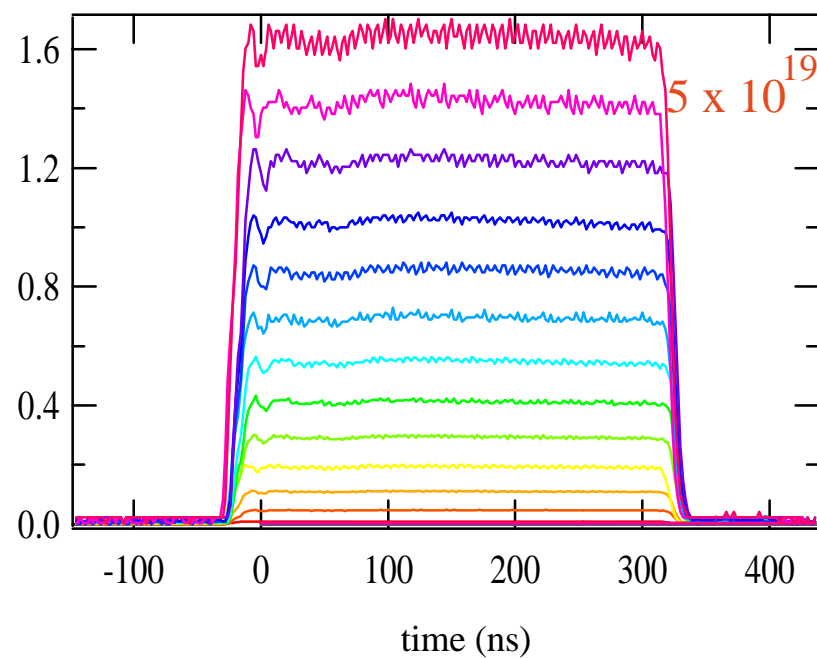
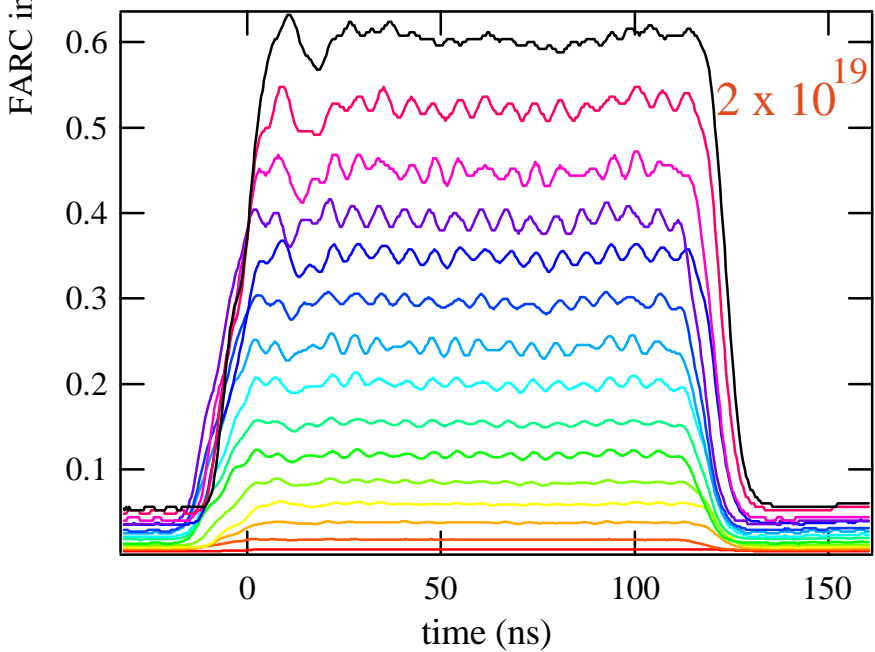
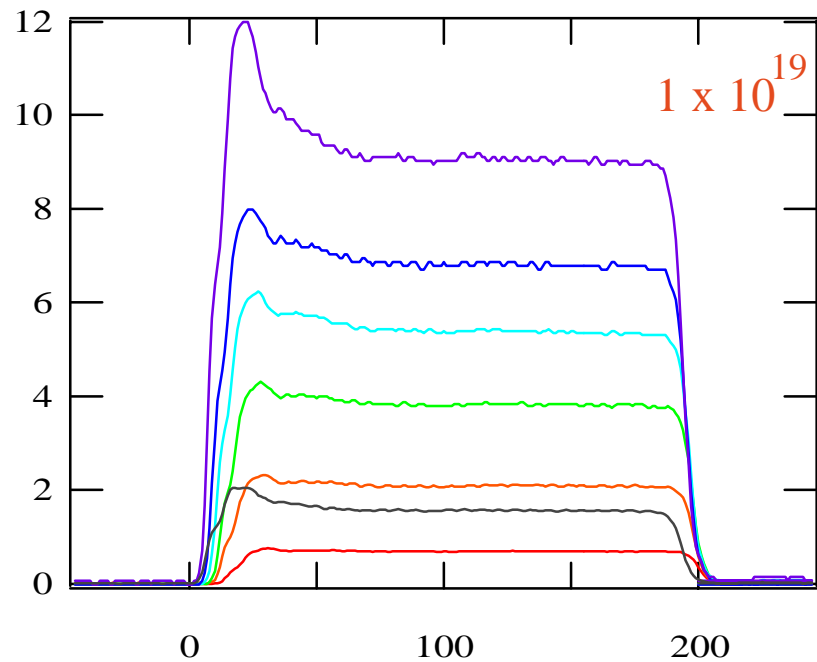
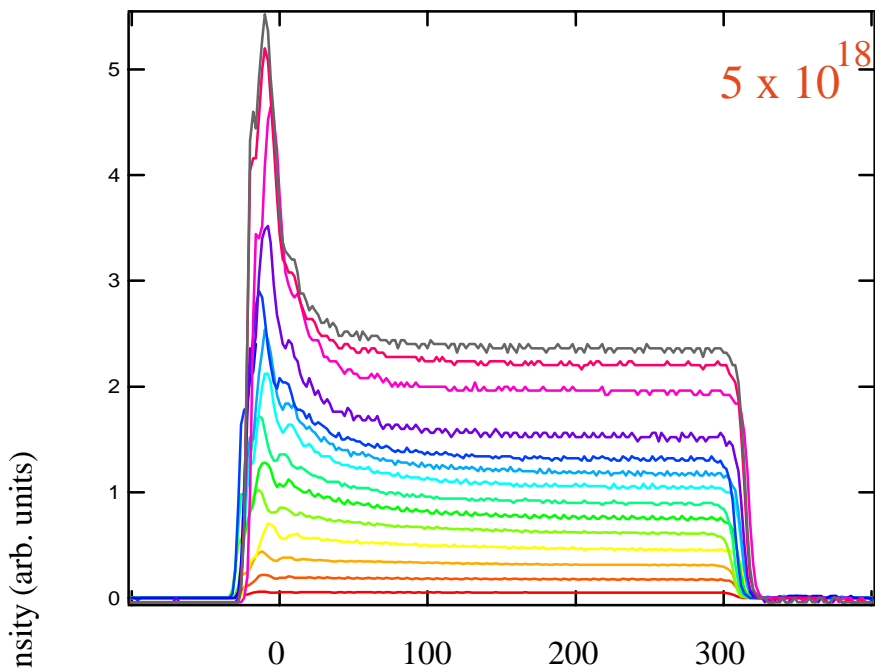
-- Pump-probe technique

$$\lambda = 850 \text{ nm}$$

Gun Test Laboratory

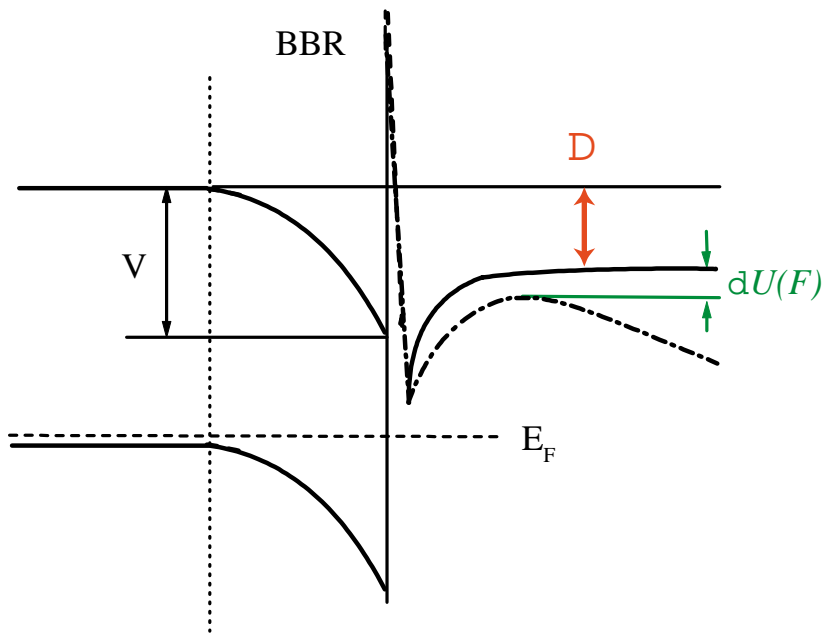


Faraday Cup Signal



Subashiev's Charge Limit Model based on Surface Photovoltage

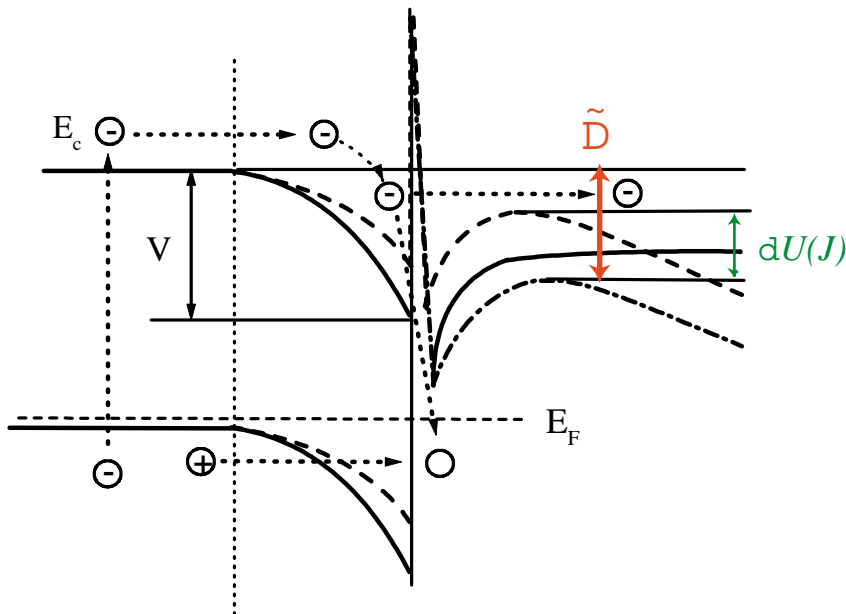
● Bias effect on Yield "Shottky effect"



$$\frac{dY}{Y} = + \frac{dU(F)}{D}$$

$$dU(F) = \sqrt{\frac{q F (e_s - 1)}{4 p e_0 (e_s + 1)}}$$

● Photovoltage effect on Yield



$$\frac{dY}{Y} = - \frac{dU(J)}{\tilde{D}}$$

● Restoring Current

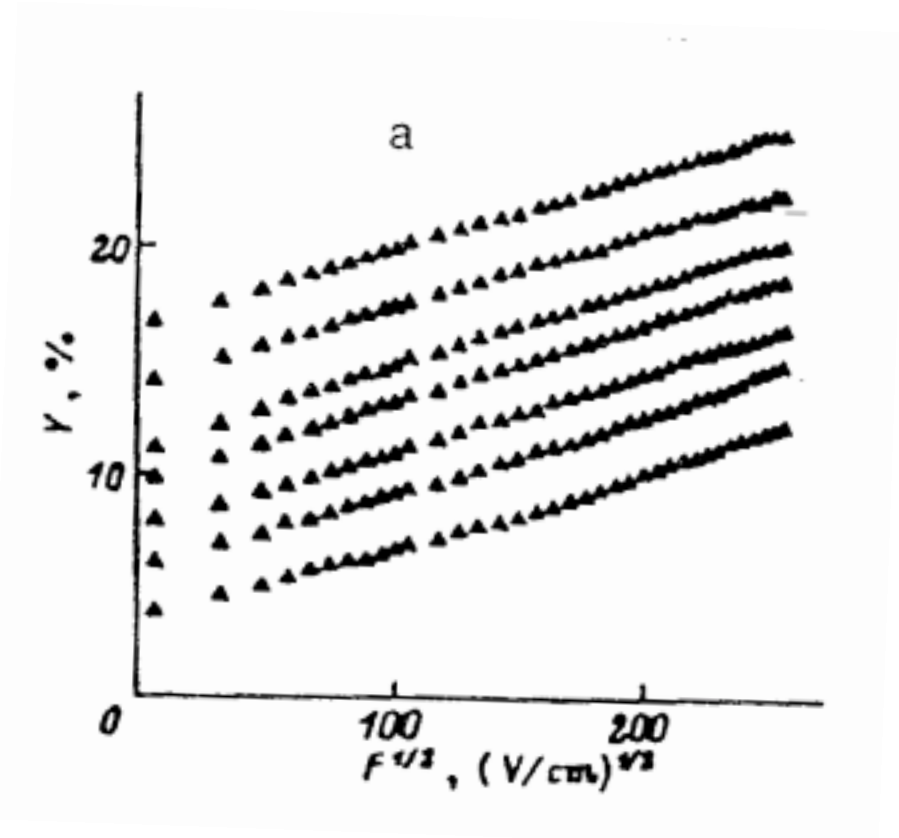
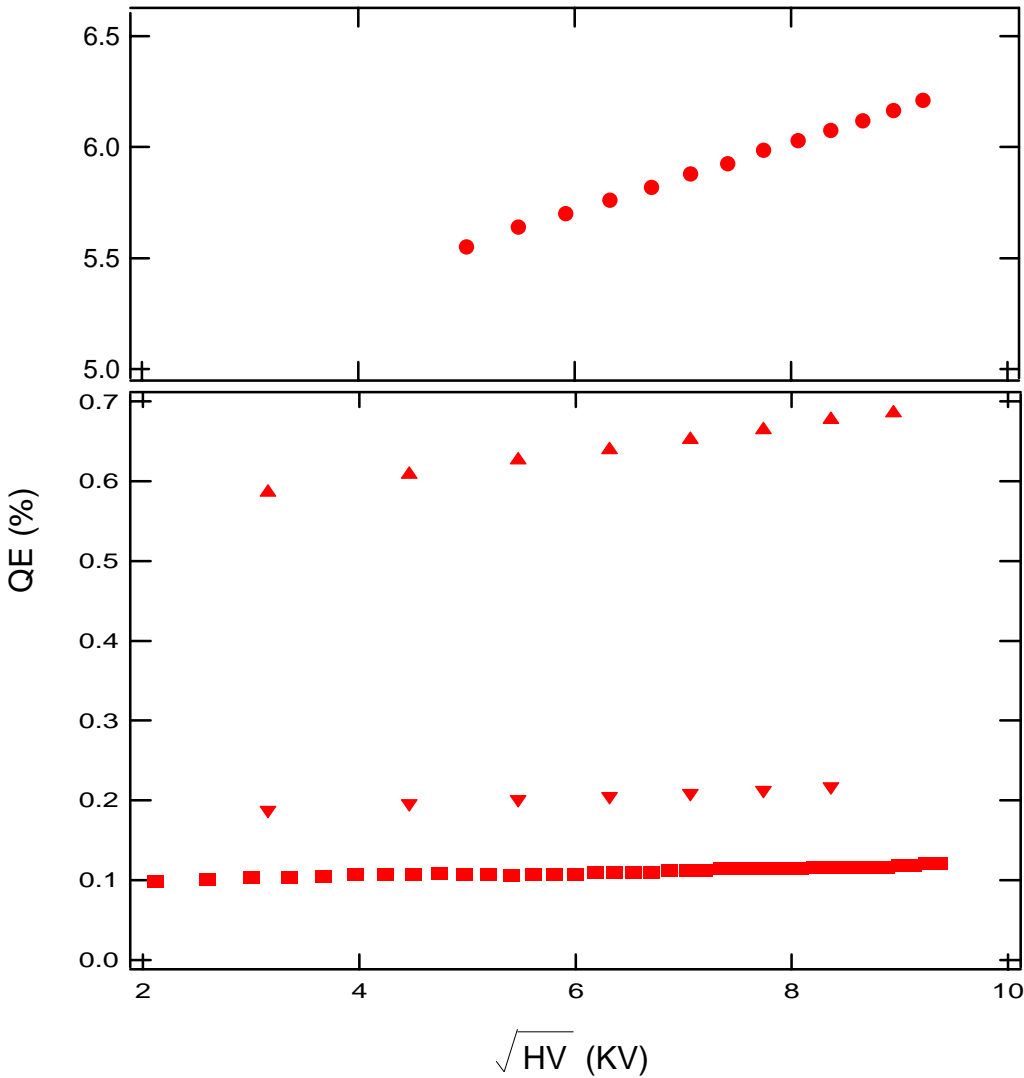
$$j(U) = j_0 [\exp(U / E_0) - 1]$$

Bias Effect on Quantum Yield

$$\frac{dY}{dF} = + \frac{dU(F)}{D}$$

$$dU(F) = 47 \text{ meV @ } 120 \text{ KV}$$

$$D \sim 135 \text{ meV}$$



A.S. Terekhov et al, Sov. Phys.-Solid State 38, 196 (1996)

The time variation of the photovoltage:

$$C \frac{dU}{q^2 dt} = \alpha d(1 - R)J - j(U)$$

C : surface capacitance

α : absorption coefficient

d : cathode thickness

R : surface reflectivity

$$\frac{Y}{Y_0} = 1 + \frac{E_0}{\tilde{\Delta}} \ln \left[\frac{1 + J / \tilde{j}_0 \exp[-(1 + J / \tilde{j}_0) \frac{t}{\tau}]}{(1 + J / \tilde{j}_0)} \right]$$

Photovoltage Build-up Time

$$T = \frac{\tau}{(1 + J / \tilde{j}_0)}$$

Photovoltage relaxation time

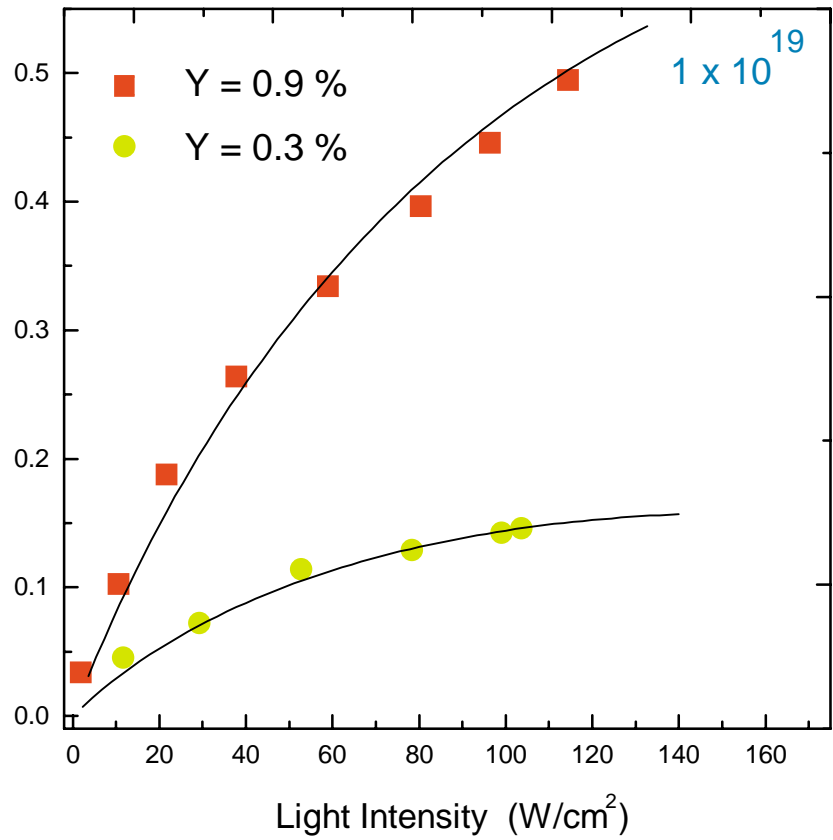
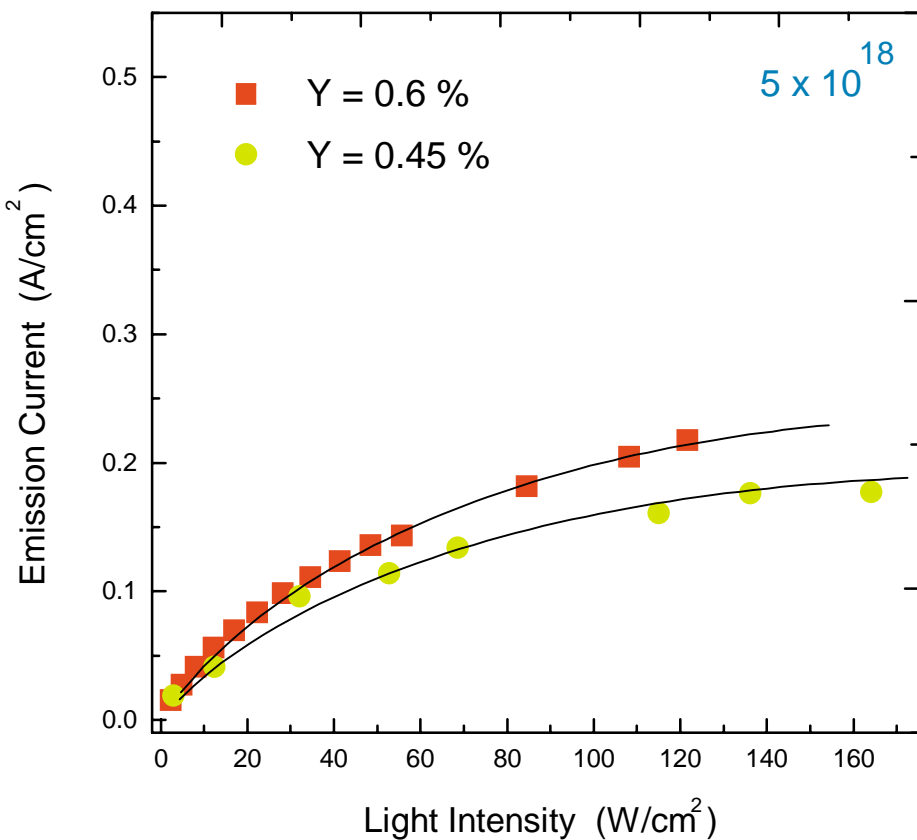
$$\tau = \frac{E_0 C}{q^2 j_0}$$

Saturation Yield

$$\frac{Y}{Y_0} = 1 - \frac{E_0}{\tilde{\Delta}} \ln(1 + J / \tilde{j}_0)$$

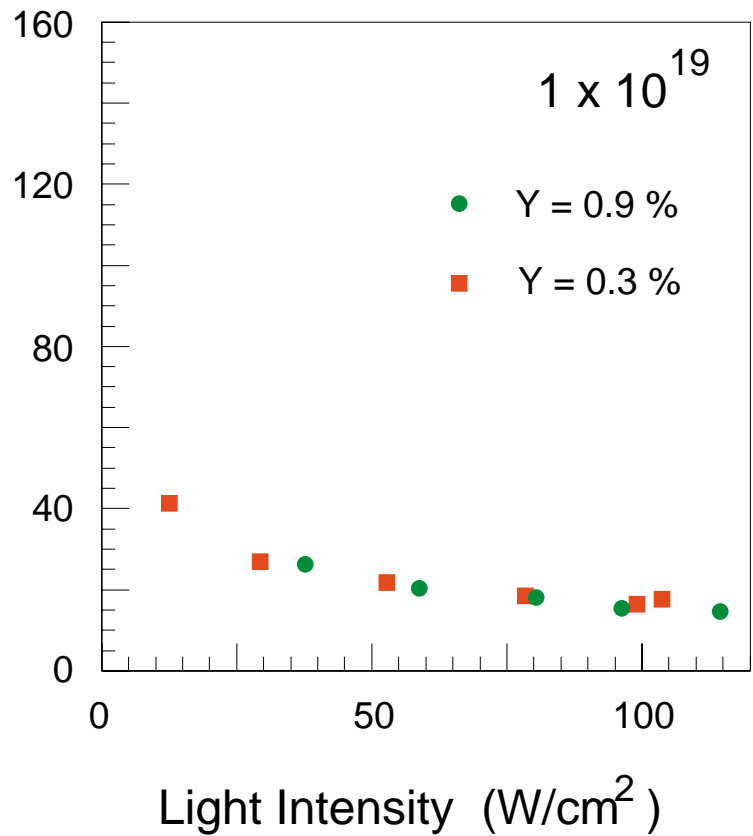
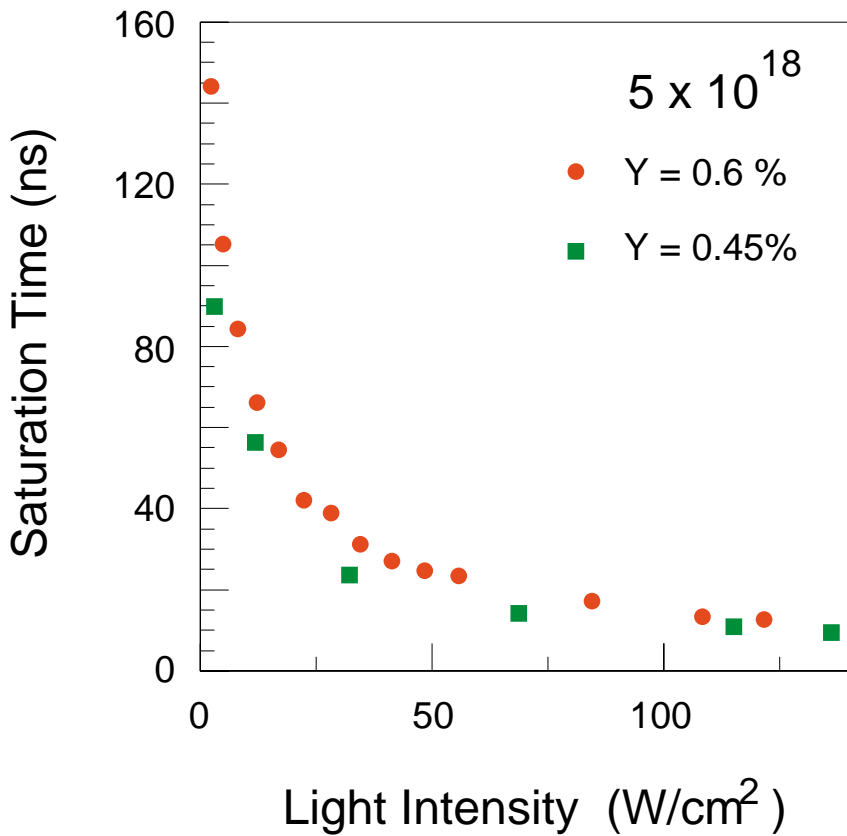
Saturation Current

$$J \left[1 - \frac{E}{D} \ln \left(1 + \frac{J}{j_0} \right) \right]$$

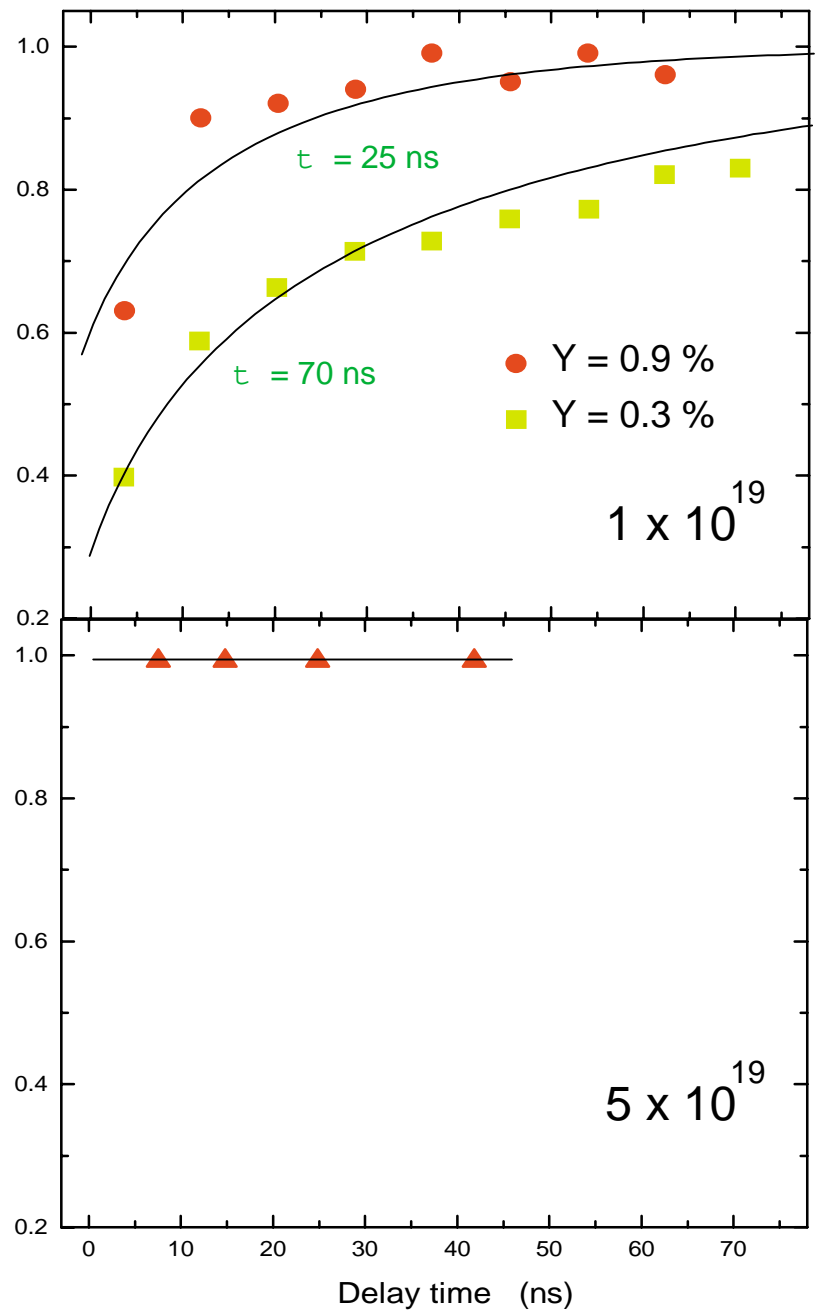
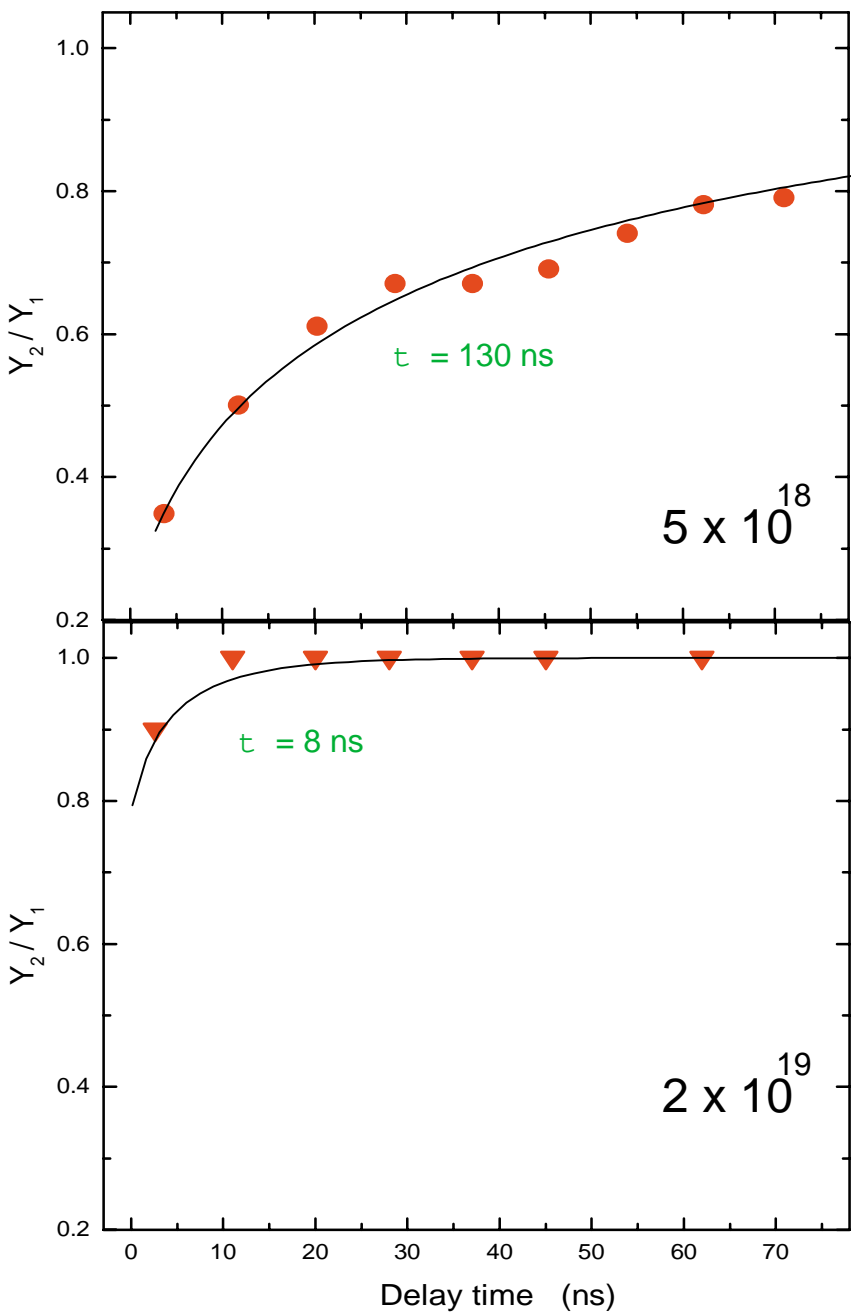


Saturation Time

$$\frac{\tau}{\left(1 + \frac{J}{J_0}\right)}$$

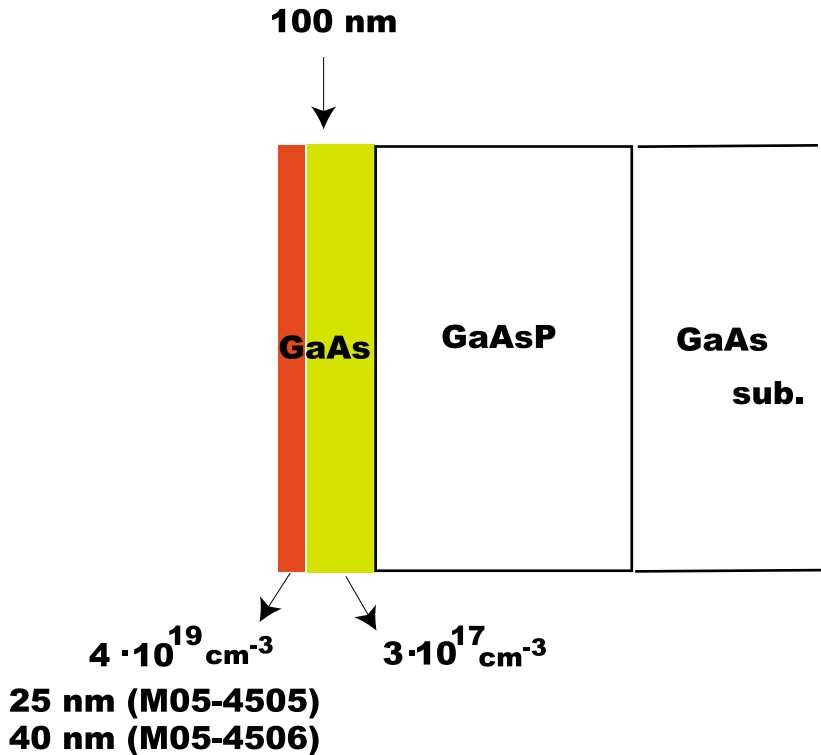


Charge Restoration



Polarization with High Surface Doping

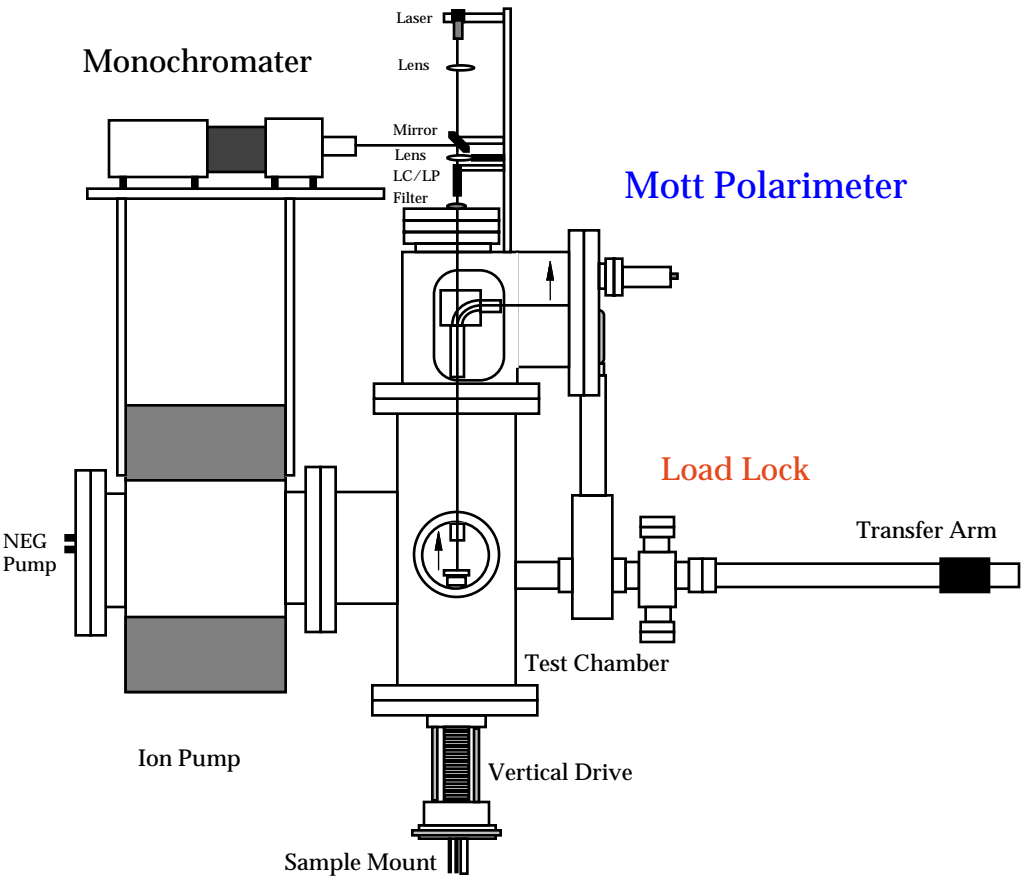
Sample: strained GaAs



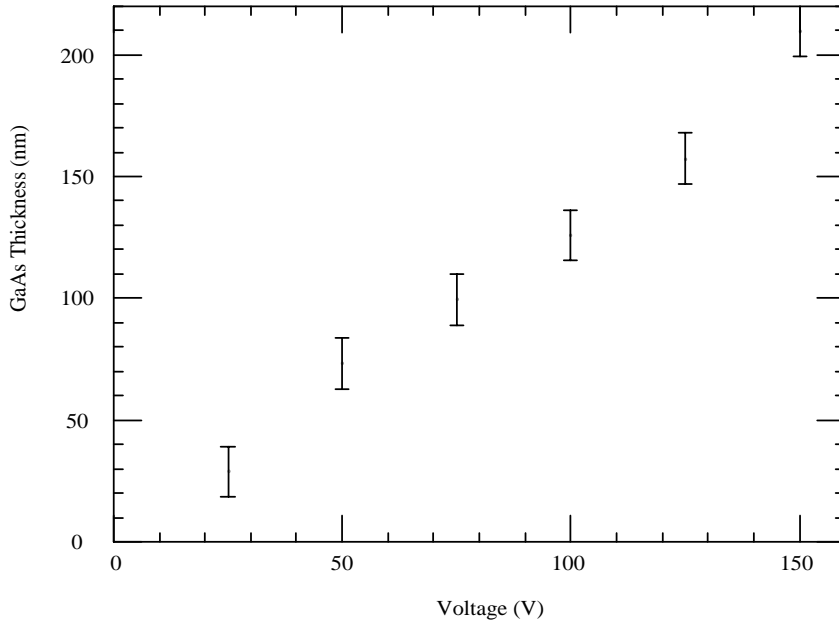
High doped layer thickness is reduced by anodization.

Polarization is measured as a function of the high doped layer thickness.

Cathode Test System with a load-lock



Anodization rate

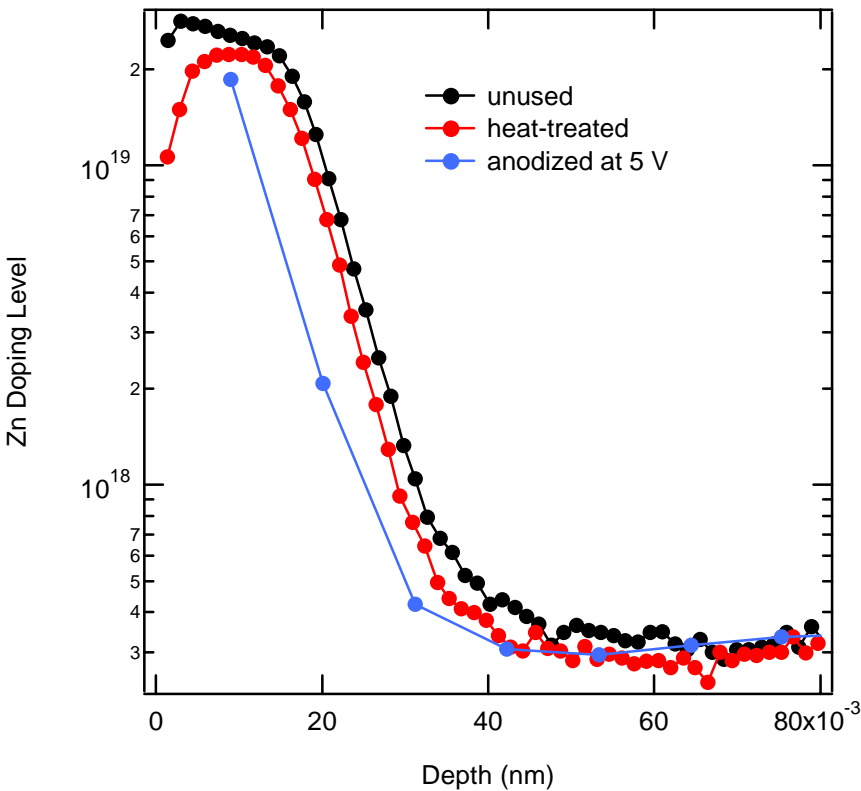


13.1 Å / V

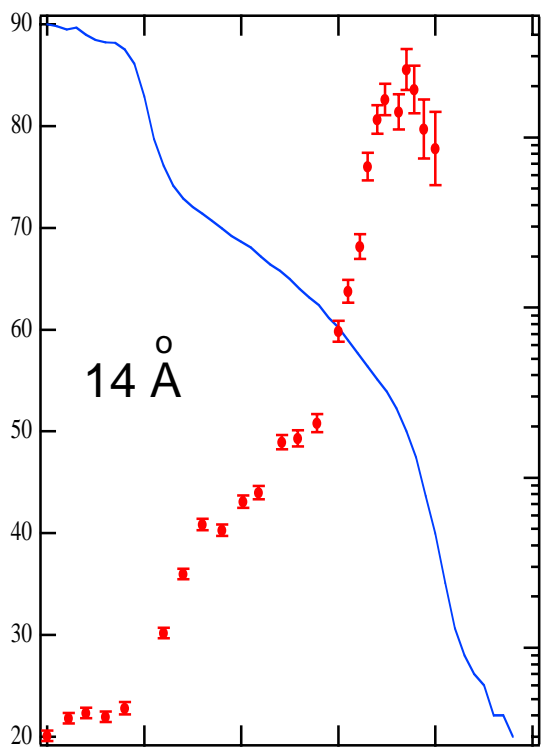
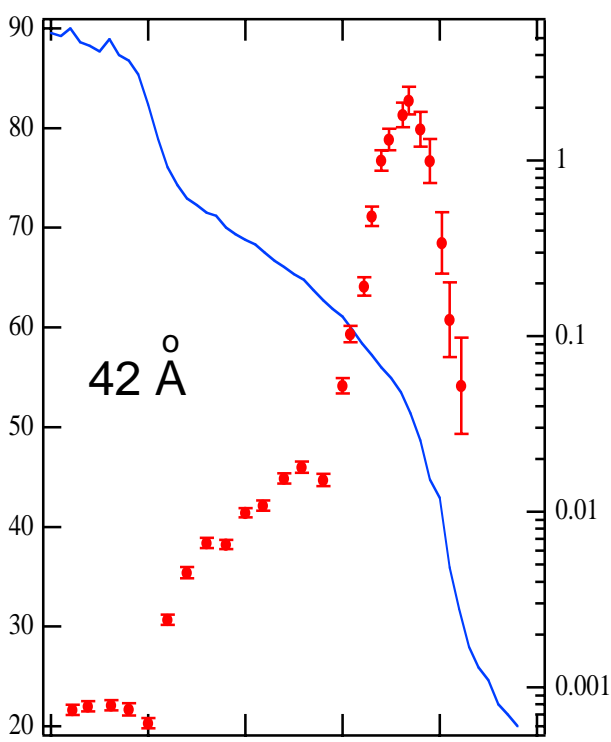
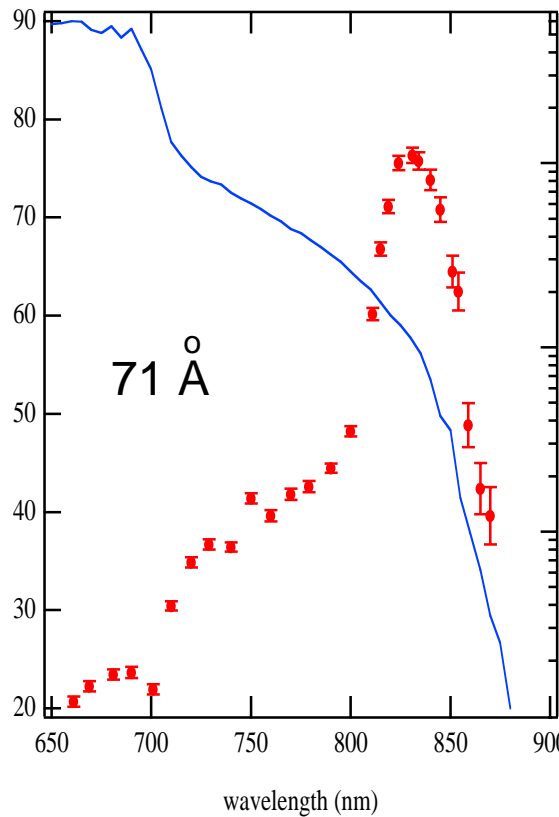
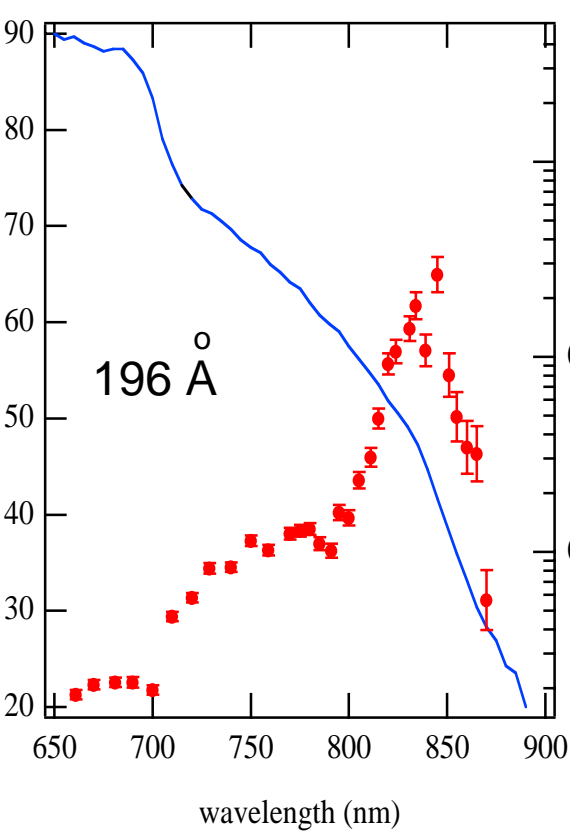
SIMS Analysis

GaAs evaporation rate at "600 C" : $\sim 4 \text{ \AA} / 1\text{hr}$

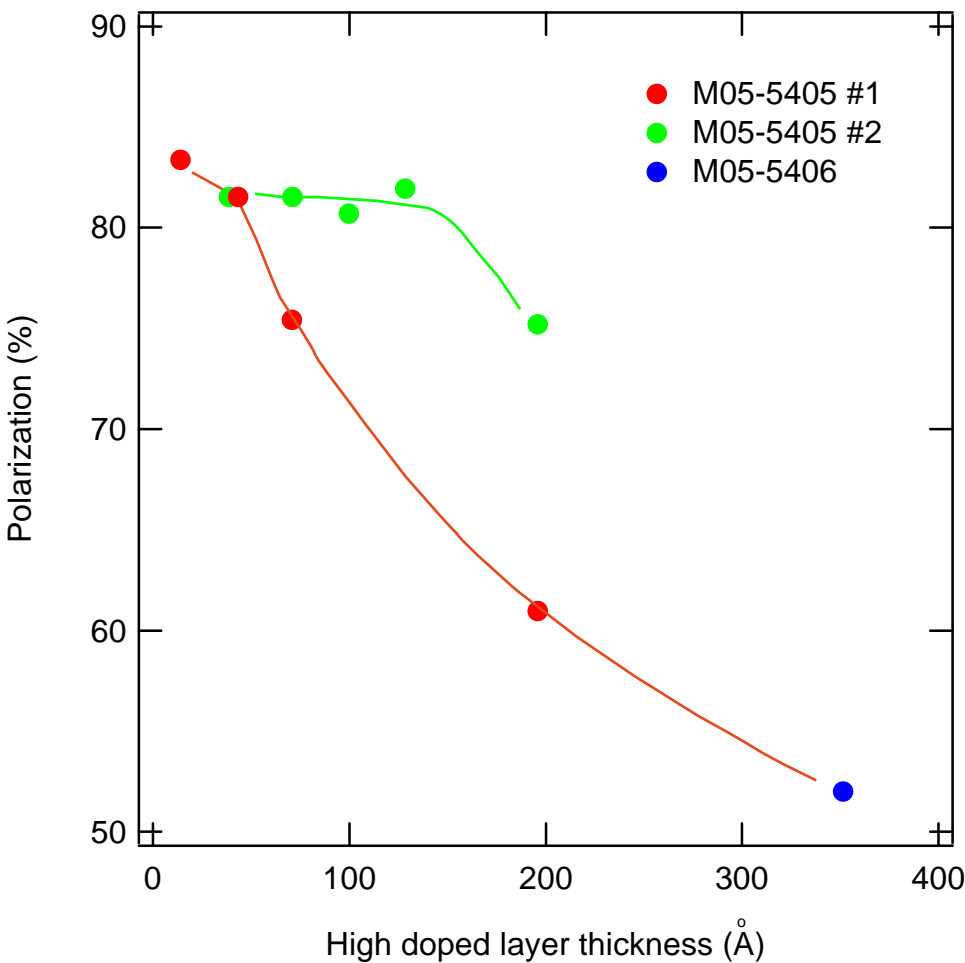
Anodization rate at 5 V : 14.9 \AA



Polarization and QE Measurements



Polarization vs High Doped Layer Thickness



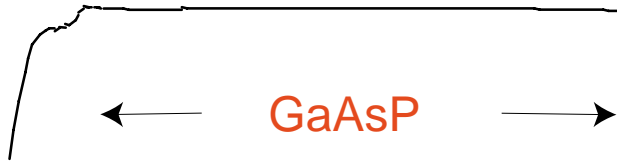
~80 % polarization with 50 ~ 100 Å of high surface doping.

Possible Solutions for Charge Limit

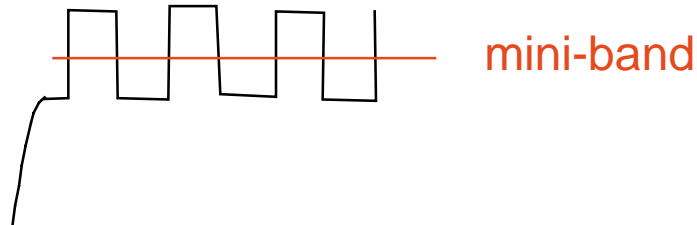
- Strained GaAs with high surface doping



- Strained GaAsP with high surface doped GaAs cap



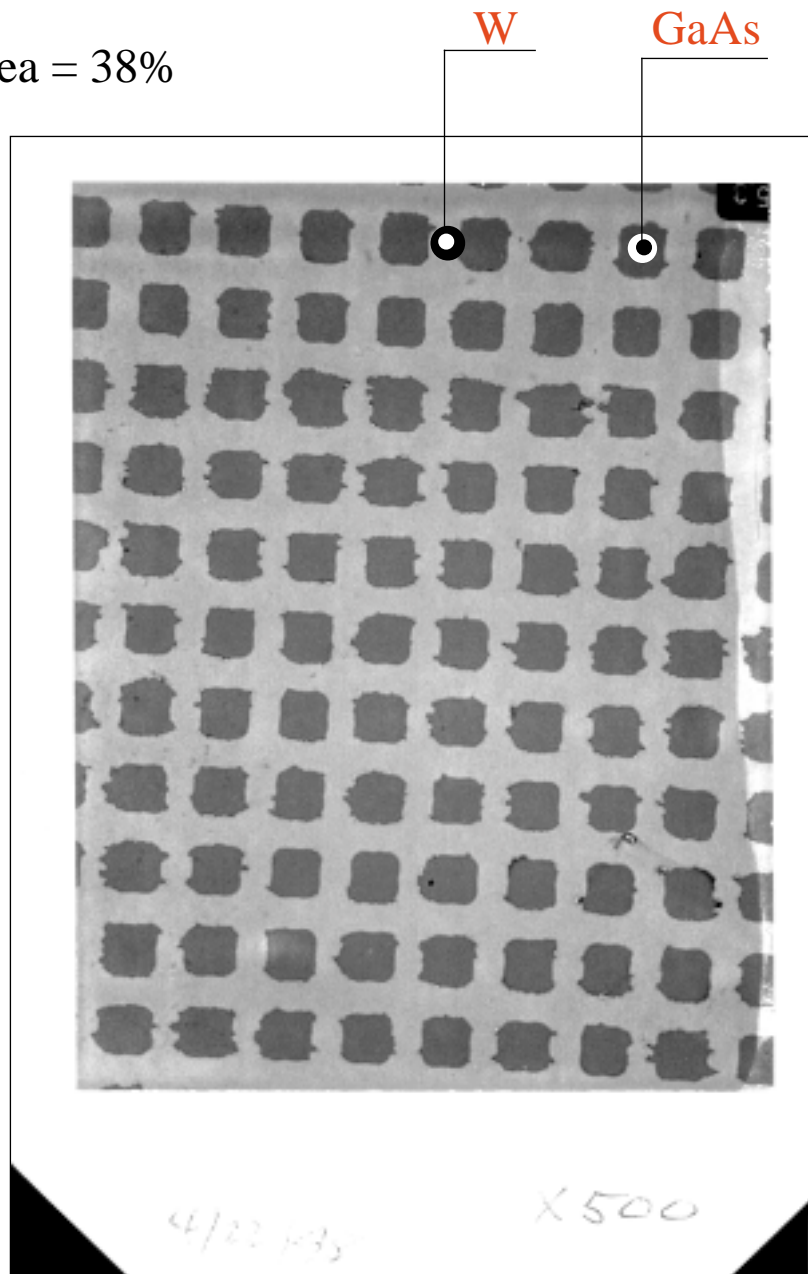
- Superlattice - Nagoya Group



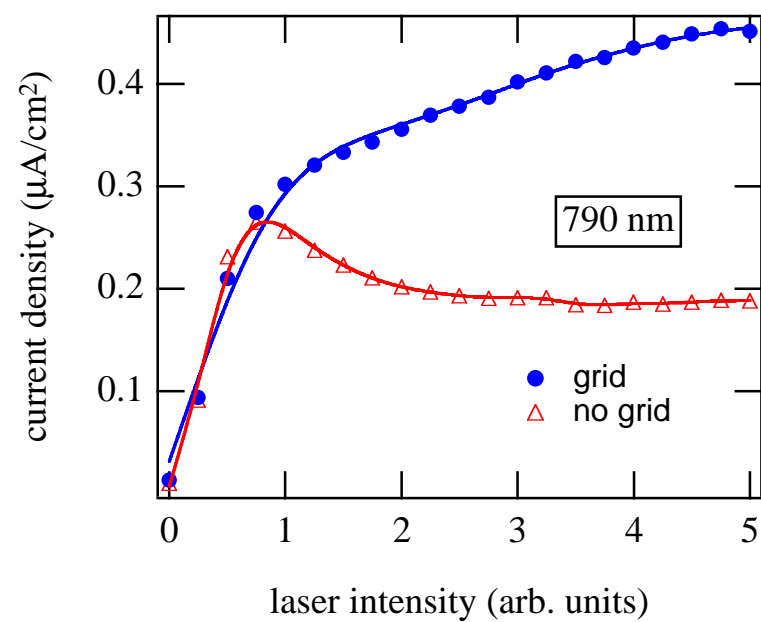
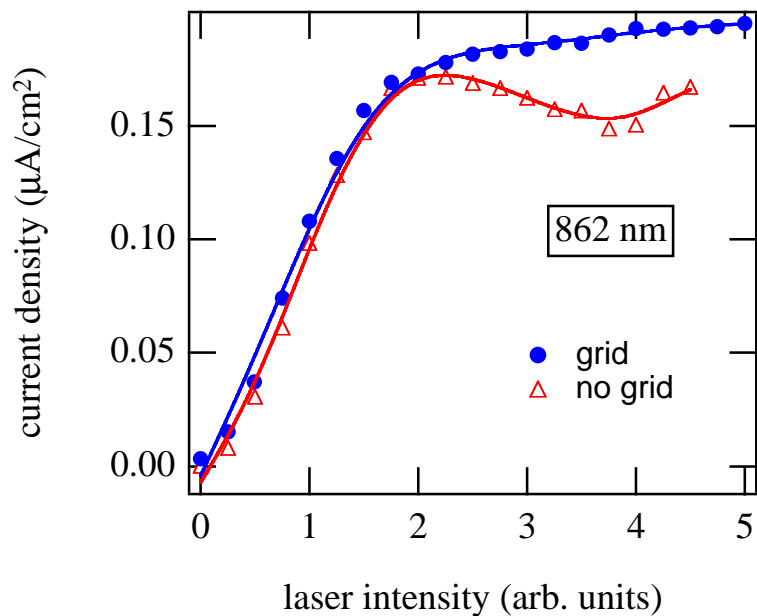
- Metallic Grid

Charge Bleedoff Grid

- Tungsten chosen for robustness and for low reactivity
- Lithographic techniques used for deposition
- Line width = $10\ \mu\text{m}$ with $23\ \mu\text{m}$ spacing
- Line height = $30\ \text{nm}$
- Clear area = 38%



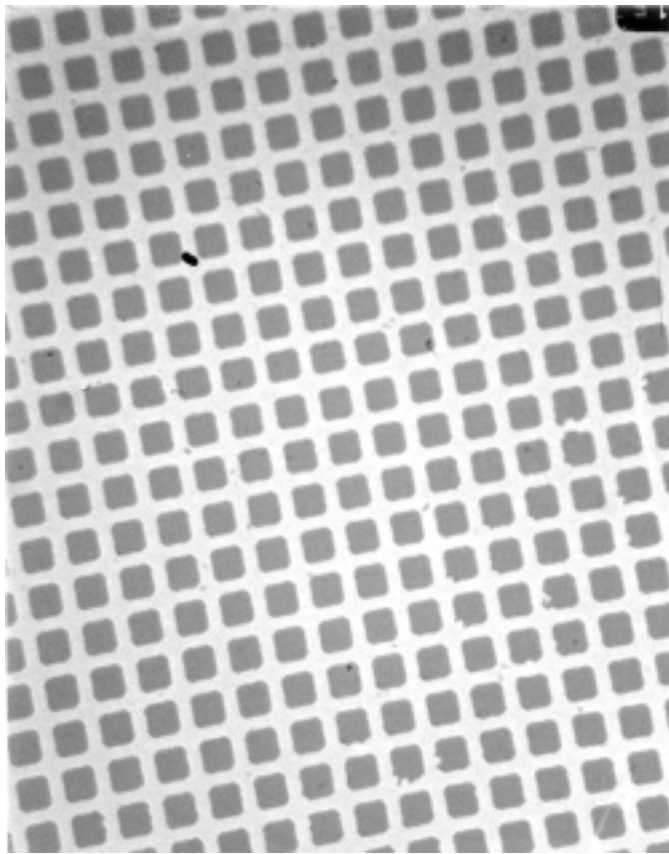
Current density enhancement using W grid
QED 100 nm unstrained GaAs
 $1 \times 10^{18} / \text{cm}^3$ Be doping



Depositting Finer Grid on GaAs

2 μm

4 μm



Summary

- Systematic study of the charge limit effect has been completed.
- Experimental results are in good agreement with Subashiev's model based on the surface photovoltage effect.
- The surface photovoltage effect diminishes at the doping concentration of $2 \times 10^{19} \text{ cm}^{-3}$.
- Possible solutions to the charge limit problem are described.